

A

B

C

D

E

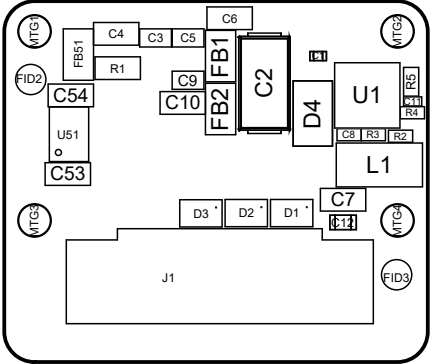
ASSEMBLY NOTES:

Assembly shall conform to IPC-A-610 Class 2.
Assembly shall conform with RoHS Directive 2011/65/EU.
Components shall be placed according to the associated CPL and BOM documents.
Lead-free SAC305 solder shall be used.
Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.
BGA components shall be 100% checked with x-ray for solder bridges after reflow.
Finished assemblies shall be removed from panel prior to delivery.

Notes:

- 1
- 2
- 3
- Camera module will be supplied and installed by customer. J2 is SMT connector only.

View from Top side (Scale 2)



Title: DM0255	
Number: D000103	Revision: R1M1 E1
Date: 23/08/2021	Sheet: 1 of 2
Drawn by: David Malovrh	



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A

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E

A

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C

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1

2

2

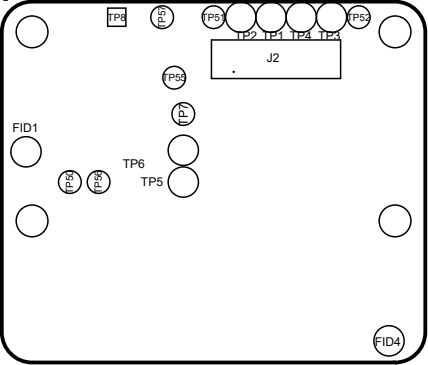
3


3

4

4

[Variant: [All Variants]]: View from Bottom side (Scale 2)



Title: DM0255		
Number: D000103	Revision: R1M1 E1	
Date: 23/08/2021	Sheet: 2 of 2	PROPRIETARY AND CONFIDENTIAL
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